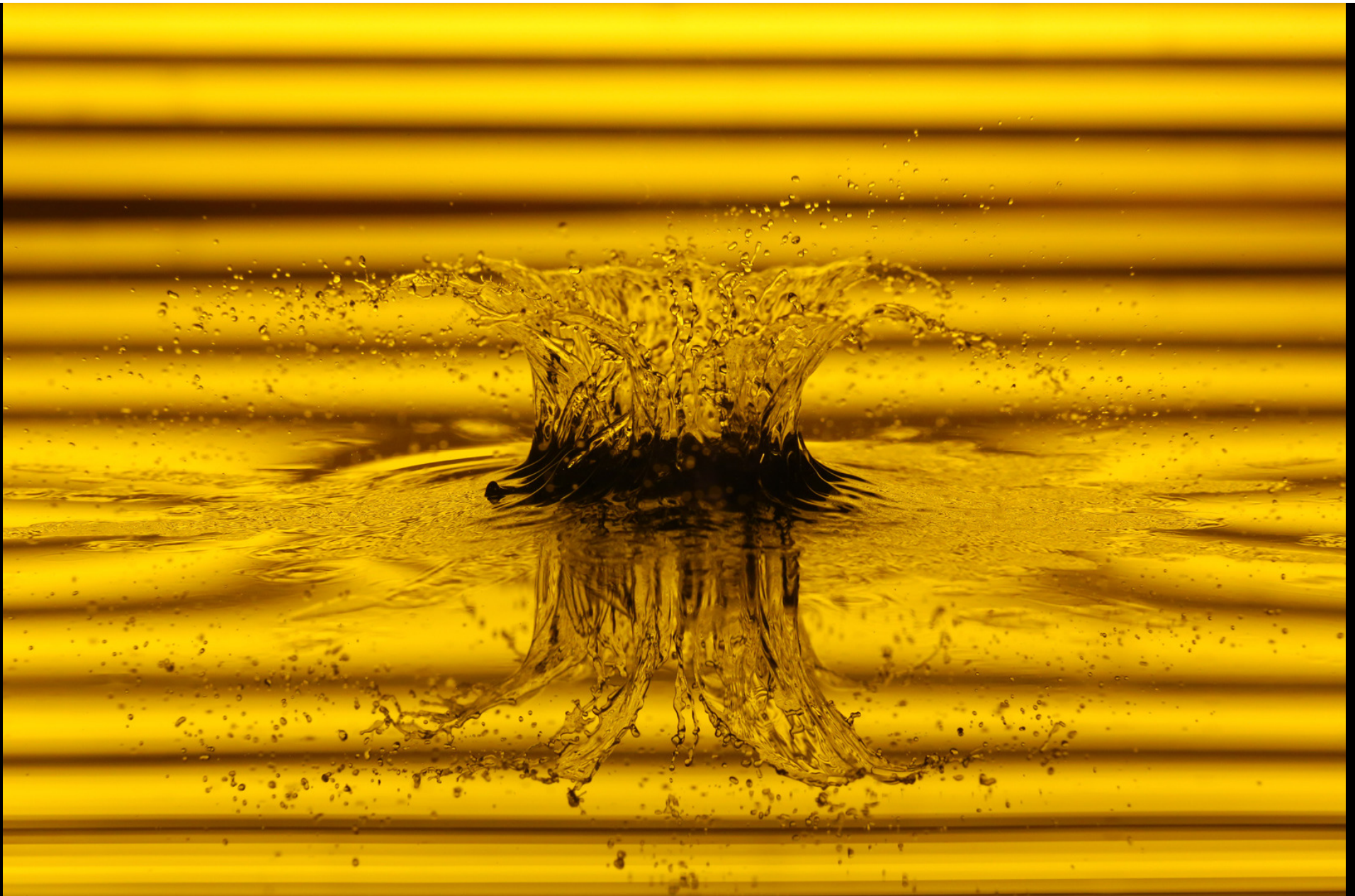


# Software controlled high speed photography

A high-speed photograph of a person in a yellow dress jumping into water, creating a large splash. The person is in the center, with their arms and legs extended. The water is captured in mid-air, forming a large, white, star-like splash around the person. The background is dark, making the white water and yellow dress stand out.

Lex Augusteijn  
November 2018



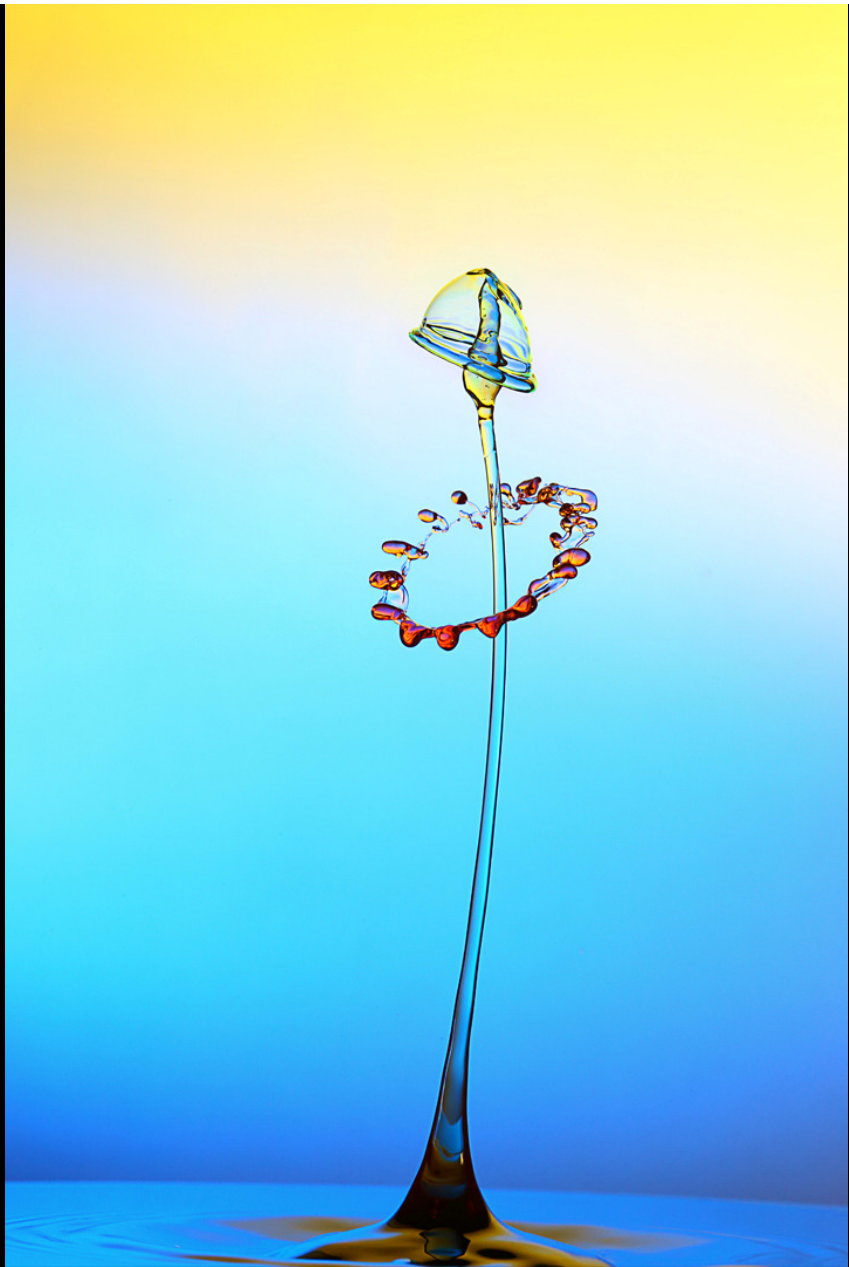
















# How to take such pictures?

- Exposure time as short as 40  $\mu\text{s}$
- Exposure time  $\neq$  shutter time
- Dark scene
- Open shutter (for e.g. 1/10 sec)
- Synchronize events (drops, bullets, ...)
- Fire flash(es)
- Exposure time = flash duration

# 2005: Analog equipment

Light gate



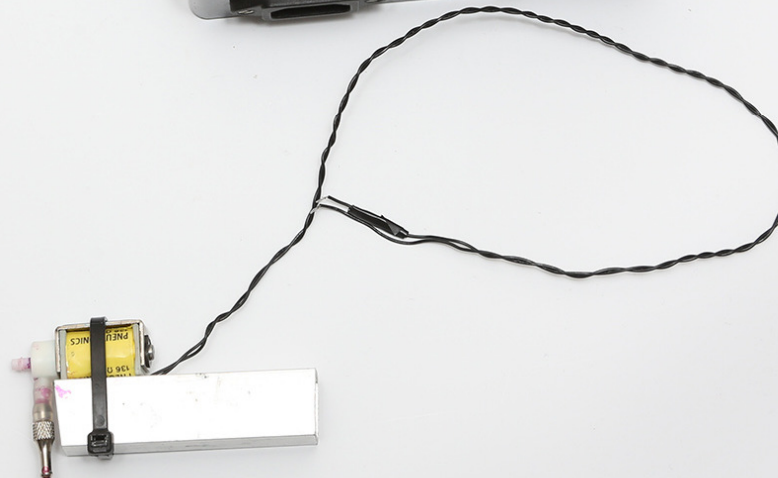
Sound trigger



Adjustable delay

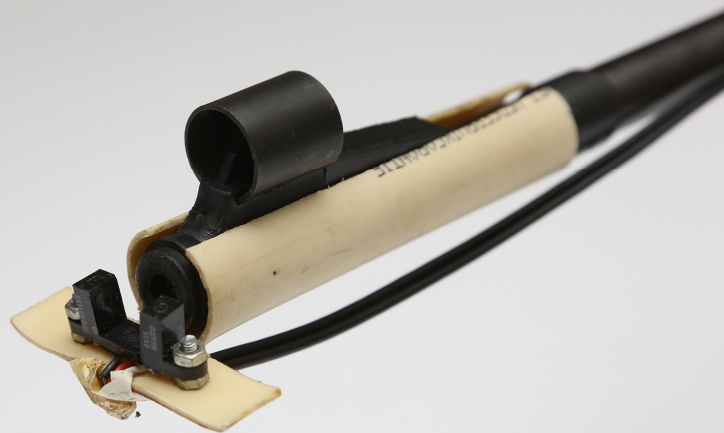


Valve



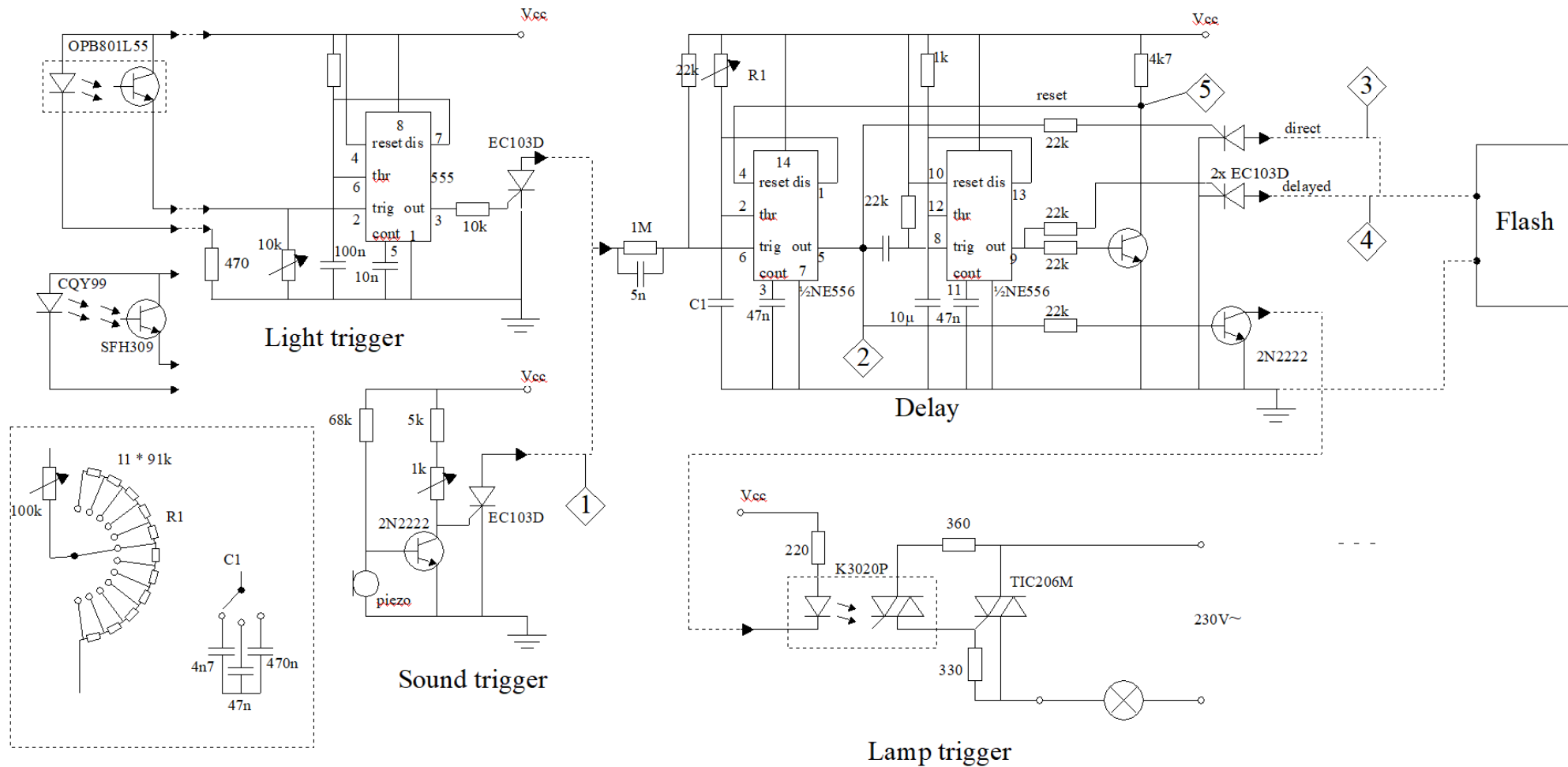


# Analog equipment



# Analog equipment

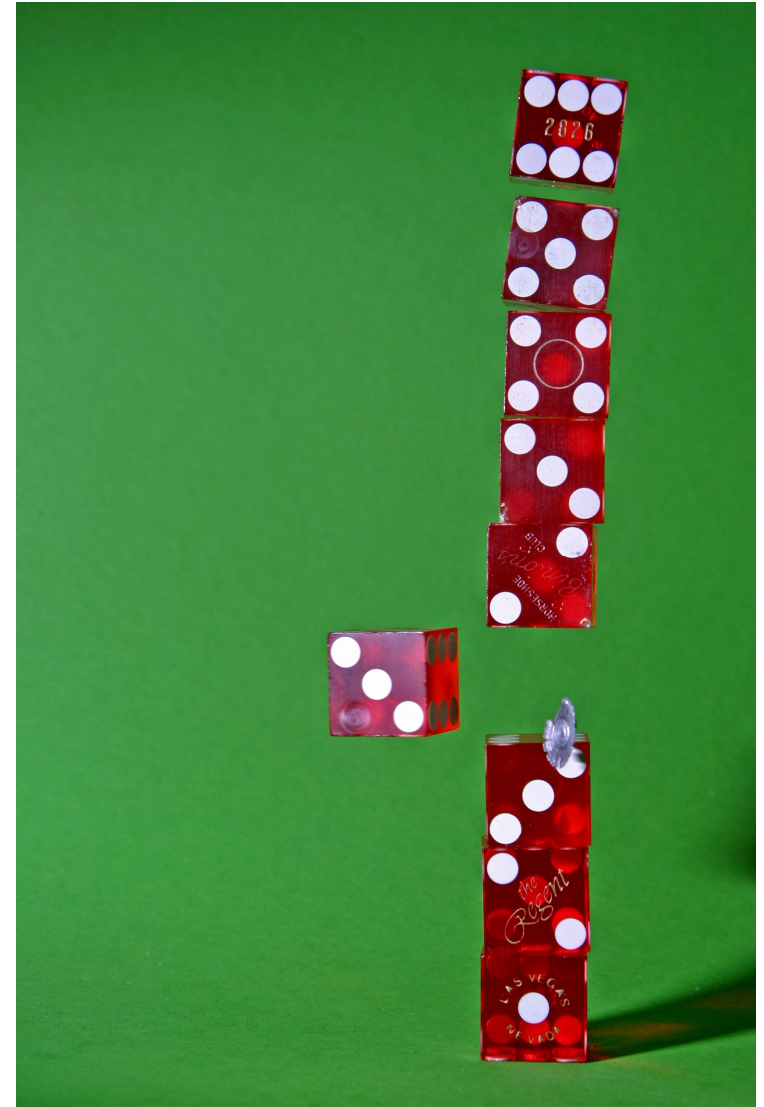
- Original analog timer, 500  $\mu$ s .. 0.5 sec





# Draw-backs of analog equipment

- Precision
- Reproducibility
- Pellet iso bullet
- One input, one output event
  - Optical, audio input
  - Flash output
  - No shutter control, no valves
- Need event before input
  - Valve before gun
- Go digital!

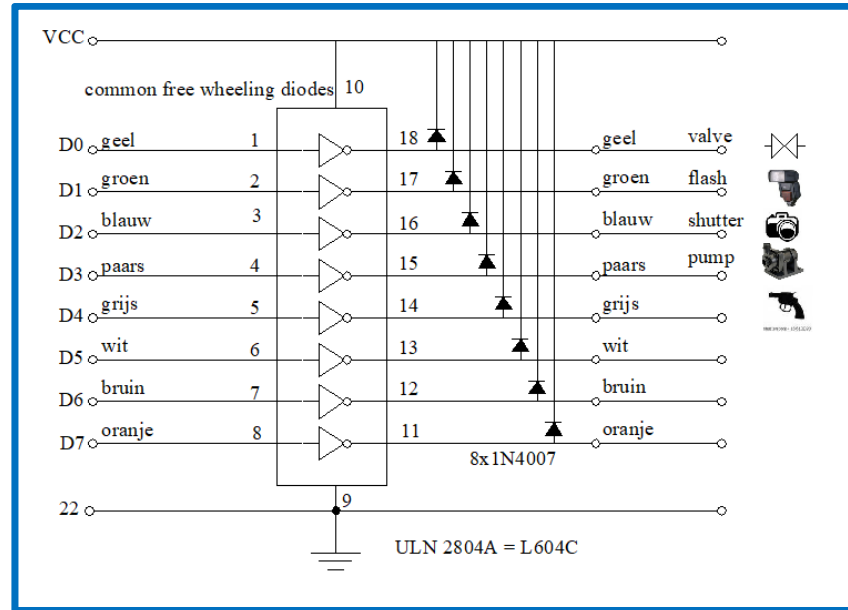


# Digital equipment

- Laptop with parallel(!) port

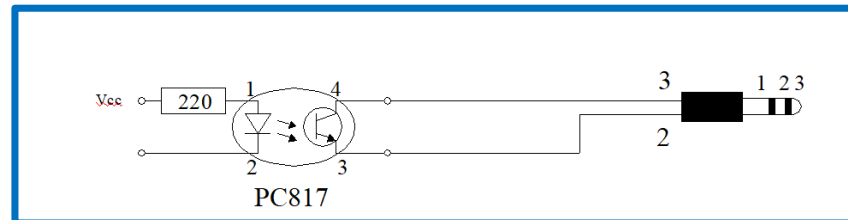


- Open collector driver



- Opto coupler to insulate sensitive devices (like camera!)

- Wiring to
  - Flashes
  - Camera
  - Valves
  - Pump
  - Gun





# Software

- Redhat 9, single user, no network
  - Minimal latency
- Running as root (sbit) to get access to parallel port
- Control parallel port through MMIO: 1  $\mu$ s resolution
  - `void outb(unsigned char value, unsigned short int port);` // port = 0x378
- Language to specify events and actions
- Implement through Front (<http://front.sourceforge.net>)

# Software

## Drop control code

```
port valve
port flash
port shutter
port pump
port gun

event pump    action pump    duration 700 ms    start

event drop1   action valve   duration 55 ms    100 ms after pump

event drop2   action valve   duration 45 ms    134 ms after drop1

event camera  action shutter duration 500 ms    350 ms after drop1

event light   action flash   duration 10 ms    150 ms after camera

event shoot   action gun     duration 7 ms     124 ms after camera
```

## Drop grammar in Front

```
events ::= ports : { Port }
        events : { Event } ;

Port ::= "port" SP id : DEFINING Ident NAMESPACE PORT NL
        value : Int = 0 ;

Event ::= "event" SP id : DEFINING Ident NAMESPACE EVENT SP
        "action" SP
        port : APPLIED Port NAME Ident SP
        duration : [ "duration" SP Time SP ]
        < StartEvent ::= "start"
        | InputEvent ::= "input"
        | TimedEvent ::= t : Time SP "after" SP pred : APPLIED Event NAME Ident
        > NL
        ticks : clock_ticks = 0    %% time at which the event should happen
        action : Action = NULL    %% Action to be executed
        arg : Int = 0             %% Argument to action
        passed : clock_ticks = -1 %% time at which the event happened
        ;

Time ::= t : Int SP
        unit : TimeUnit ;

TimeUnit ::= < u_time ::= "us"
            | m_time ::= "ms"
            | s_time ::= "s"
            > ;
```



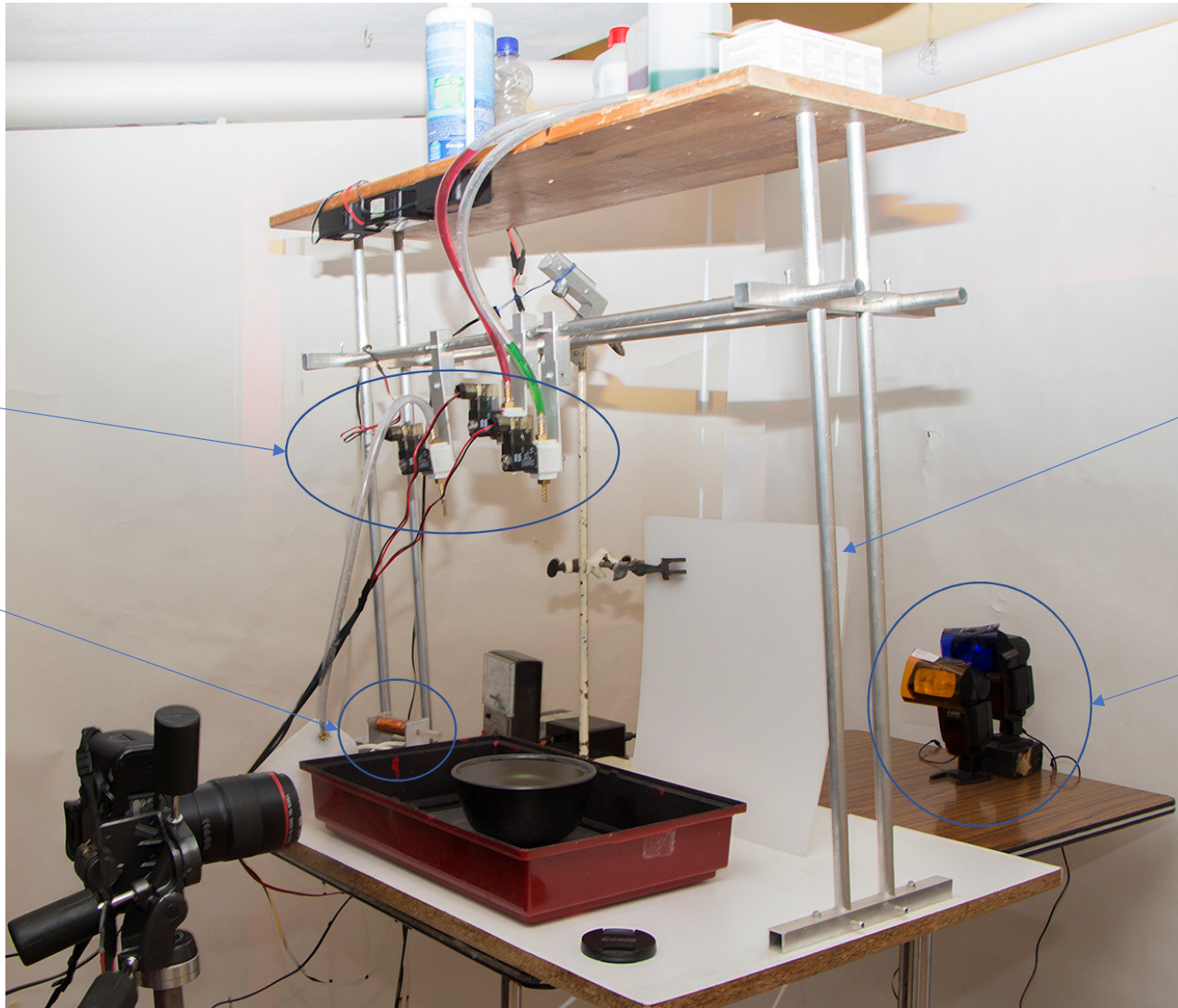
# Setup

Valves

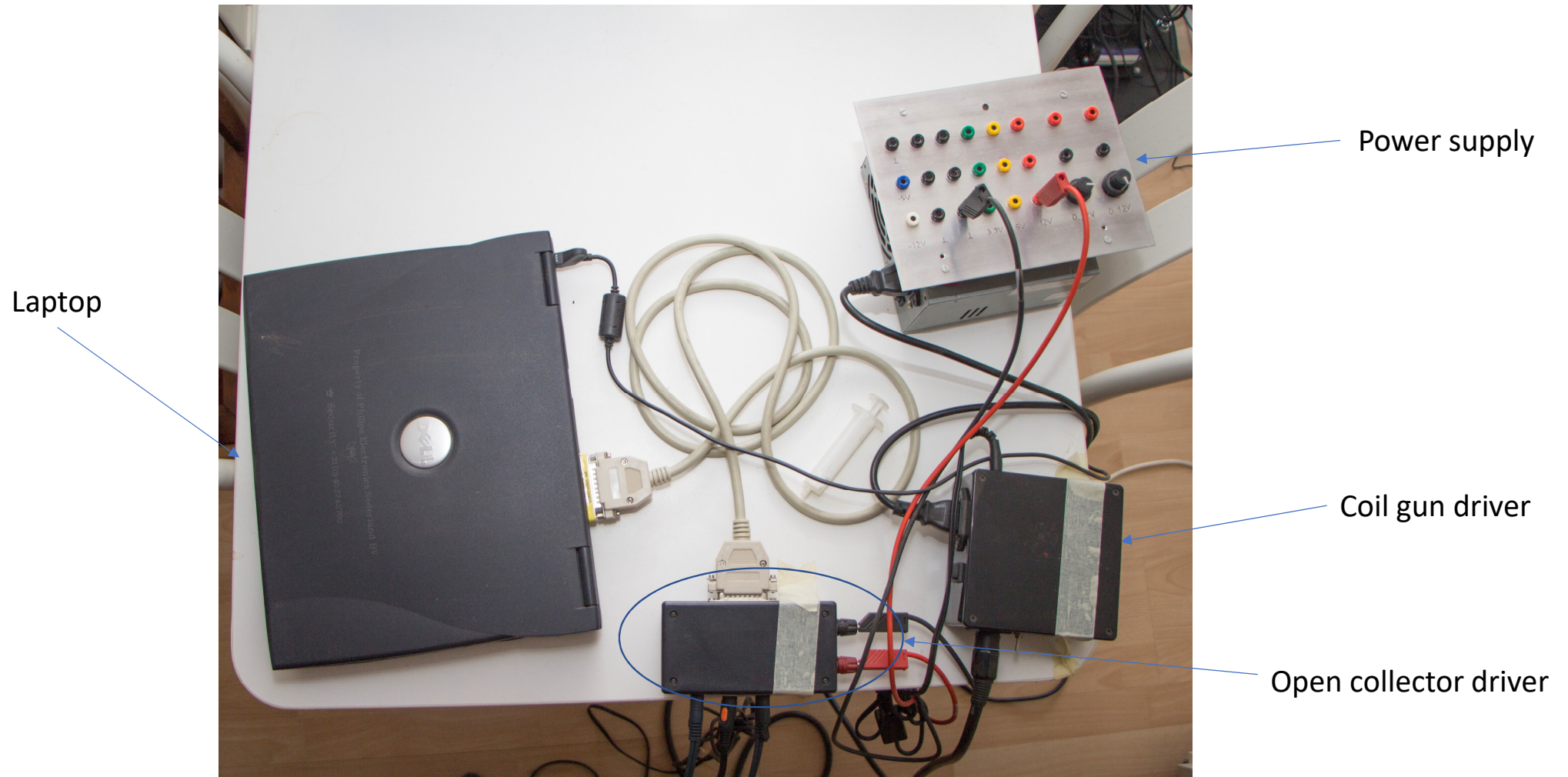
Coil gun

Diffusor

Flashes



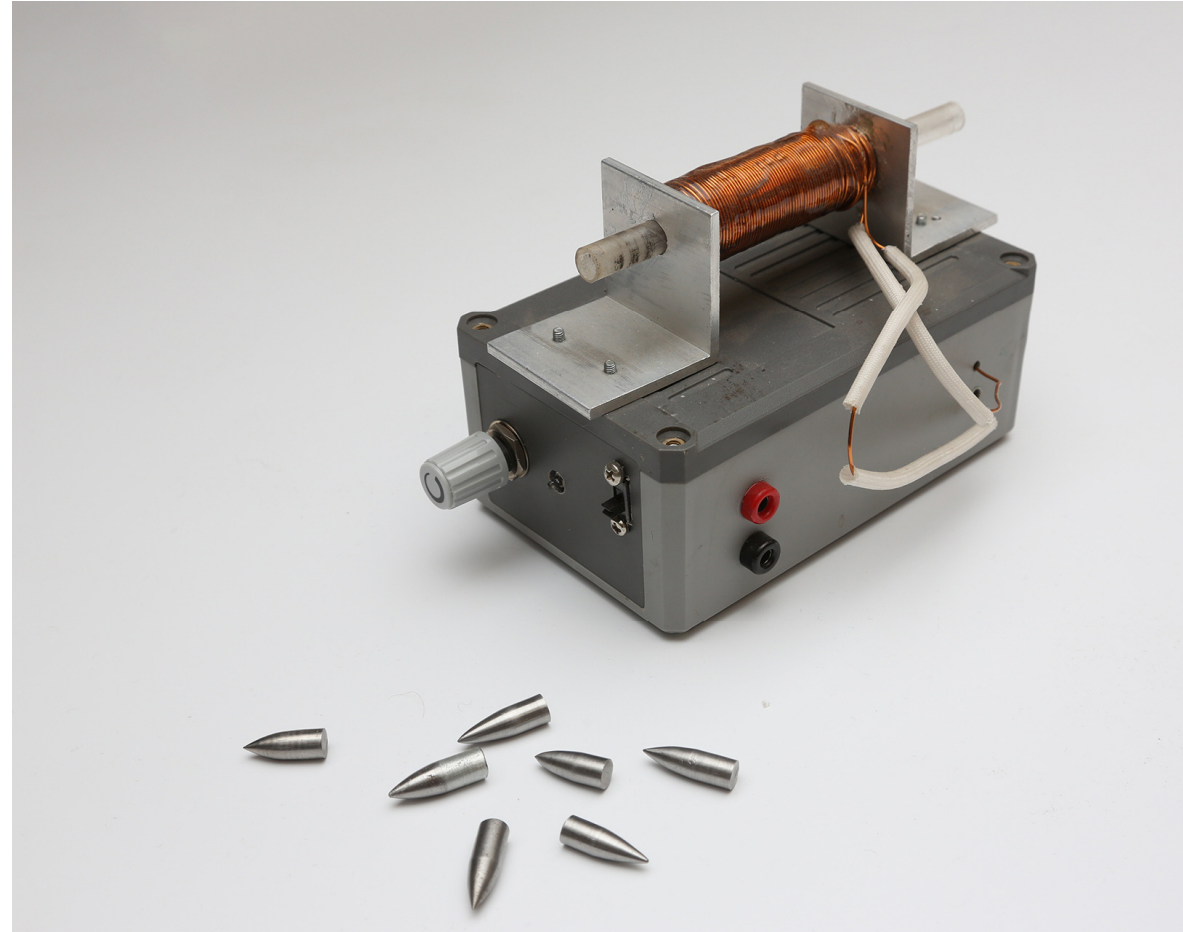
# Setup





# Coil gun

- Charge capacitor ( $\sim 1\text{mF}$ ) to 200-300V
- Dozens of Joules ( $\frac{1}{2} CV^2$  : lethal!)
- Short-circuit over big coil
- Strong induction peak
- Pull steel bullet through coil
- Timing very precise
- Control bullet speed by pulse duration



- How to switch 300V and 100A within microseconds?
- IGBT (used in induction cooktop)



## IRG4PC50UDPbF

INSULATED GATE BIPOLAR TRANSISTOR WITH  
ULTRAFAST SOFT RECOVERY DIODE

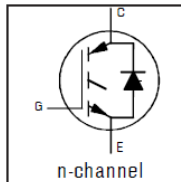
UltraFast CoPack IGBT

## Features

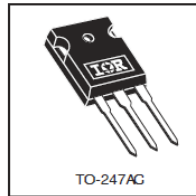
- UltraFast: Optimized for high operating frequencies 8-40 kHz in hard switching, >200 kHz in resonant mode
- Generation 4 IGBT design provides tighter parameter distribution and higher efficiency than Generation 3
- IGBT co-packaged with HEXFRED™ ultrafast, ultra-soft-recovery anti-parallel diodes for use in bridge configurations
- Industry standard TO-247AG package
- Lead-Free

## Benefits

- Generation 4 IGBT's offer highest efficiencies available
- IGBT's optimized for specific application conditions
- HEXFRED diodes optimized for performance with IGBT's. Minimized recovery characteristics require less/no snubbing
- Designed to be a "drop-in" replacement for equivalent industry-standard Generation 3 IR IGBT's



n-channel

 $V_{CES} = 600V$   
 $V_{CE(on)} \text{ typ.} = 1.65V$   
@  $V_{GE} = 15V, I_C = 27A$ 

TO-247AG

## IGBT

## Absolute Maximum Ratings

	Parameter	Max.	Units
$V_{CES}$	Collector-to-Emitter Voltage	600	V
$I_C @ T_C = 25^\circ C$	Continuous Collector Current	55	A
$I_C @ T_C = 100^\circ C$	Continuous Collector Current	27	
$I_{CM}$	Pulsed Collector Current ①	220	
$I_{LM}$	Clamped Inductive Load Current ②	220	
$I_F @ T_C = 100^\circ C$	Diode Continuous Forward Current	25	
$I_{FM}$	Diode Maximum Forward Current	220	

## Absolute Maximum Ratings

	Parameter	Max.	Units
$V_{CES}$	Collector-to-Emitter Voltage	600	V
$I_C @ T_C = 25^\circ C$	Continuous Collector Current	55	A
$I_C @ T_C = 100^\circ C$	Continuous Collector Current	27	
$I_{CM}$	Pulsed Collector Current ①	220	
$I_{LM}$	Clamped Inductive Load Current ②	220	
$I_F @ T_C = 100^\circ C$	Diode Continuous Forward Current	25	
$I_{FM}$	Diode Maximum Forward Current	220	
$V_{GE}$	Gate-to-Emitter Voltage	$\pm 20$	V
$P_D @ T_C = 25^\circ C$	Maximum Power Dissipation	200	W
$P_D @ T_C = 100^\circ C$	Maximum Power Dissipation	78	
$T_J$	Operating Junction and Storage Temperature Range	-55 to +150	$^\circ C$
$T_{STG}$	Soldering Temperature, for 10 sec.	300 (0.063 in. (1.6mm) from case)	
	Mounting Torque, 6-32 or M3 Screw.	10 lb*in (1.1 N*m)	

## Thermal Resistance

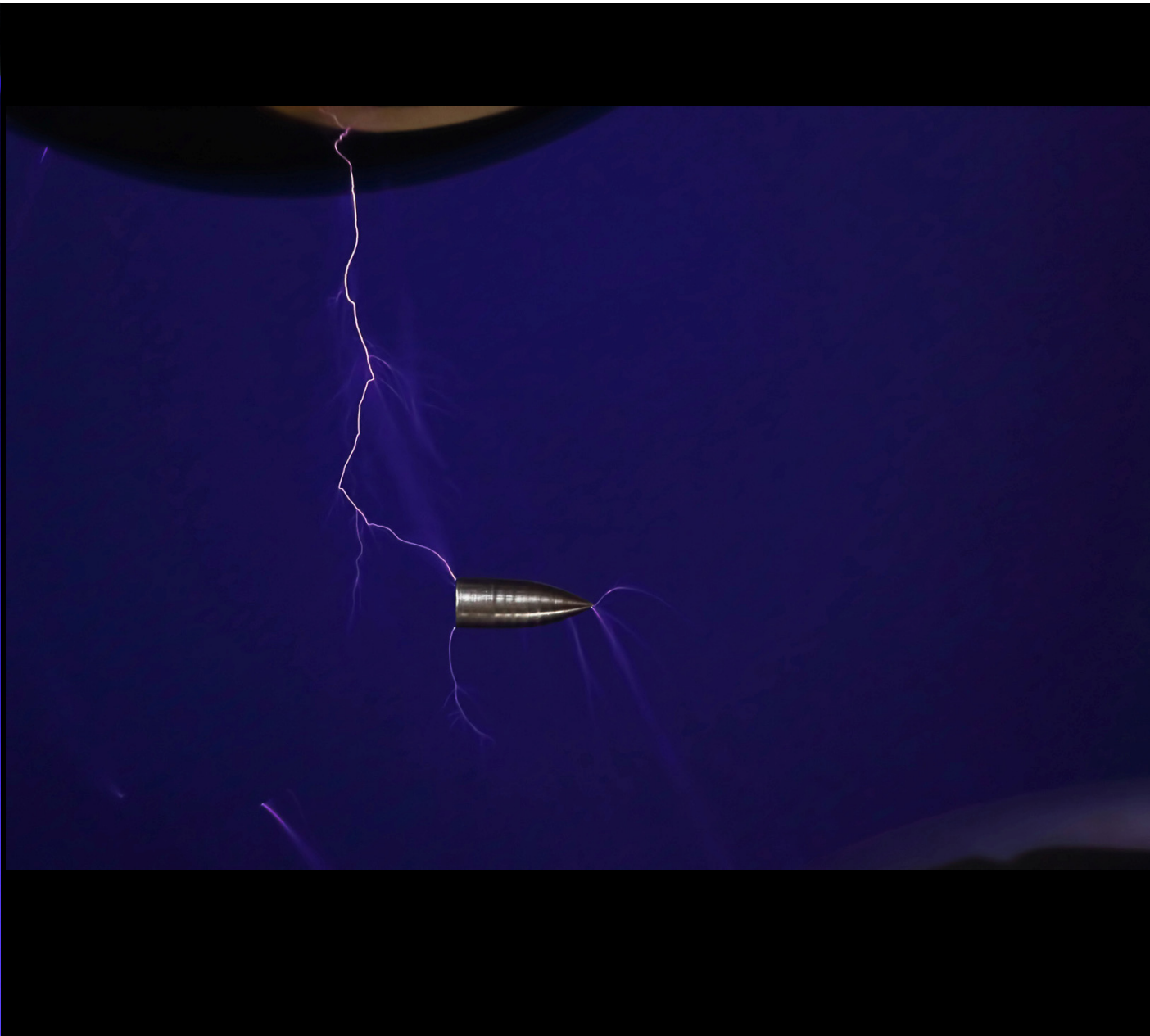
	Parameter	Min.	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case - IGBT	-----	-----	0.64	$^\circ C/W$
$R_{\theta JC}$	Junction-to-Case - Diode	-----	-----	0.83	
$R_{\theta CS}$	Case-to-Sink, flat, greased surface	-----	0.24	-----	
$R_{\theta JA}$	Junction-to-Ambient, typical socket mount	-----	-----	40	
Wt	Weight	-----	6 (0.21)	-----	g (oz)

Switching Characteristics @  $T_J = 25^\circ C$  (unless otherwise specified)

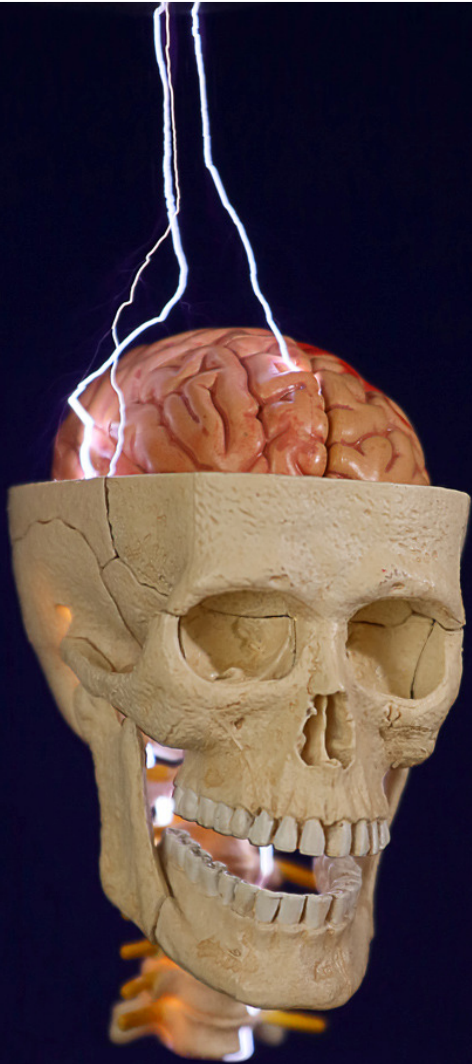
	Parameter	Min.	Typ.	Max.	Units	Conditions
$Q_g$	Total Gate Charge (turn-on)	----	180	270	nC	$I_C = 27A$ $V_{CC} = 400V$ See Fig. 8 $V_{GE} = 15V$
$Q_{ge}$	Gate - Emitter Charge (turn-on)	----	25	38		
$Q_{gc}$	Gate - Collector Charge (turn-on)	----	61	90		
$t_{d(on)}$	Turn-On Delay Time	----	32	----	ns	$T_J = 25^\circ C$ $I_C = 27A, V_{CC} = 480V$ $V_{GE} = 15V, R_G = 5.0\Omega$
$t_r$	Rise Time	----	20	----		
$t_{d(off)}$	Turn-Off Delay Time	----	170	260		
$t_f$	Fall Time	----	88	130		

# High voltage









Thank you!